



RoHS

MESSRS: _____

APPROVAL NO

710 - 1345

DATE

2024.10.16

ALUMINUM ELECTROLYTIC

CAPACITOR**APPROVAL SHEET**

CATALOG TYPE	BLA 25 VC 100 (M) (Φ 6.3 × 8.0 L)
USER PART NO.	
适用机种	
特记事项	Halogen-Free

QINGDAO SAMYOUNG ELECTRONICS CO.,LTD

MANAGER OF DEVELOPMENT DEPARTMENT

GONG JANG SUG

USER APPROVAL:

APPROVAL NO.: _____

SamYoung(Korea) : 47, SAGIMAKGOL-RO, JUNGWON-GU, SEONGNAM-SI, GYEONGGI-DO, KOREA

SamYoung(China) : No.5 CHANGJIANG ROAD, PINGDU-CITY, SHANDONG-PROVINCE, CHINA

样式: H-1001-011

A4 (210×297)

**SamYoung Electronics Co., Ltd.**

APPROVAL NO. 710 - 1345	ALUMINUM ELECTROLYTIC CAPACITOR			PAGE: 1 OF 6	
				DATE: 2024.10.16	
BLA 25 VC 100 (M)			SERIES	BLA	
			RATING	25 WV	100 μF
			CASE SIZE	Φ 6.3	× 8.0 L

A. DIAGRAM OF DIMENSION

Lot No.

Symbol mark

Capacitance

Rated voltage

CASE CODE	ΦD	L	A	B	C	W	P	a	b	c
F80	6.3	7.7	6.6	6.6	7.2	0.5~0.8	1.9	1.9	3.5	1.6

B. ELECTRICAL CHARACTERISTICS

A. OPERATING TEMPERATURE RANGE	: <u>-40 ~ +105</u> °C
B. RATED VOLTAGE	: <u>25</u> VDC
C. SURGE VOLTAGE	: <u>32</u> VDC
D. CAPACITANCE TOLERANCE	: <u>± 20%</u> (at 20°C, 120Hz)
E. LEAKAGE CURRENT	: LOWER <u>25</u> μA, AFTER <u>2</u> MINS. AT 20°C
F. DISSIPATION FACTOR (TAN δ)	: LOWER <u>0.16</u> AT 20°C, 120Hz
G. MAX. RIPPLE CURRENT (mArms)	: <u>65</u> AT 105°C, 120Hz
H. TEMPERATURE CHARACTERISTIC	:
* IMPEDANCE RATIO	$Z' / Z \leq \underline{2}$ $Z'' / Z \leq \underline{3}$ AT 120Hz Z: IMP. AT 20°C, Z': IMP. AT -25°C, Z'': IMP. AT -40°C
I. LOAD LIFE	: THE FOLLOWING SPECIFICATIONS SHALL BE SATISFIED WHEN THE CAPACITORS ARE RESTORED TO 20°C, AFTER RATED VOLTAGE APPLIED FOR 5000 HOURS AT 105 °C. # CAPACITANCE CHANGE : $\leq \underline{\pm 30\%}$ OF INITIAL VALUE # TAN δ : $\leq \underline{300\%}$ OF INITIAL SPECIFIED VALUE # L. C. : \leq THE INITIAL SPECCIFIED VALUE
J. SHELF LIFE	: THE FOLLOWING SPECIFICATIONS SHALL BE SATISFIED WHEN THE CAPACITORS ARE RESTORED TO 20°C, AFTER EXPOSING THEM FOR 1000 HOURS AT 105 °C WITHOUT VOLTAGE APPLIED.THE RATED VOLTAGE SHALL BE APPLIED TO THE CAPACITORS FOR A MINIMUM OF 30 MINUTES, AT LEAST 24 HOURS AND NOT MORE THAN 48 HOURS BEFORE THE MEASUREMENTS. # CAPACITANCE CHANGE : $\leq \underline{\pm 30\%}$ OF INITIAL VALUE # TAN δ : $\leq \underline{300\%}$ OF INITIAL SPECIFIED VALUE # L. C. : \leq THE INITIAL SPECCIFIED VALUE
L. OTHERS	: SATISFIED CHARACTERISTIC <u>KS C IEC 60384-4</u>

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TAPING DIMENSIONS

FIG.1

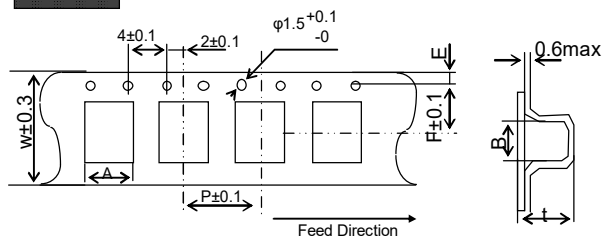


FIG.2

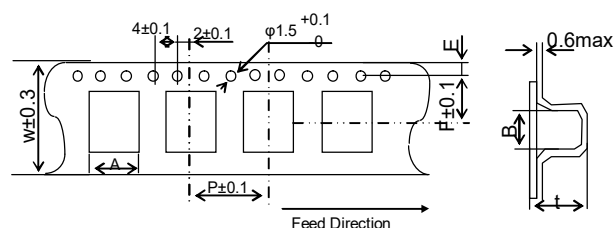


FIG.3

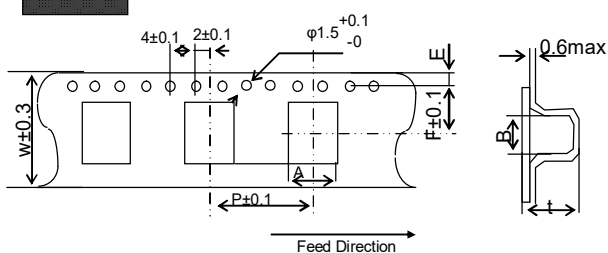
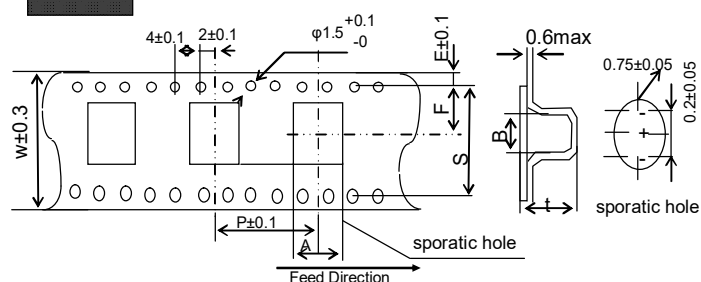
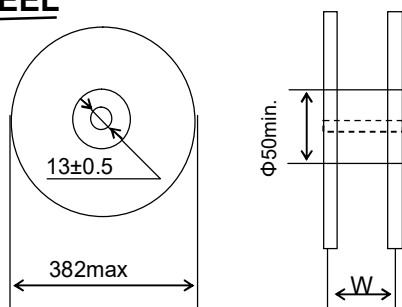


FIG.4



Case code	Fig	W	A	B	F	E	P	t	S
Φ3 (B55)	1	12	3.5±0.2	3.5±0.2	5.5	1.75±0.1	8	5.9±0.2	-
Φ4 (D55, D56, D60)	1	12	4.7±0.2	4.7±0.2	5.5	1.75±0.1	8	5.7±0.2 (D55, D56) 6.3±0.2 (D60)	-
Φ5 (E55, E56, E60)	2	12	5.7±0.2	5.7±0.2	5.5	1.75±0.1	12	5.7±0.2 (E55, E56) 6.3±0.2 (E60)	-
Φ6.3 (F55, F56, F60)	2	16	7.0±0.2	7.0±0.2	7.5	1.75±0.1	12	5.7±0.2 (F55, F56) 6.3±0.3 (F60)	-
Φ6.3×8L (F80)	2	16	7.0±0.2	7.0±0.2	7.5	1.75±0.1	12	8.2±0.2	-
Φ8×6L (H63)	2	16	8.7±0.2	8.7±0.2	7.5	1.75±0.1	12	6.8±0.2	-
Φ8×10L (H10)	3	24	8.7±0.2	8.7±0.2	11.5	1.75±0.1	16	11.0±0.2	-
Φ10×10L (J10)	3	24	10.7±0.2	10.7±0.2	11.5	1.75±0.1	16	11.0±0.2	-
Φ12.5×13.5L (K14)	4	32	13.4±0.2	13.4±0.2	14.2	1.75±0.1	24	14.0±0.2	28.4±0.1

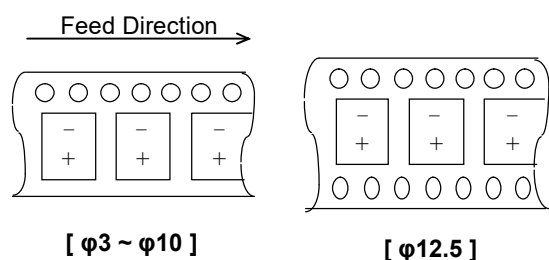
REEL



QUANTITY PER REEL

Case code	W (mm)	Q'ty (pcs/reel)	Q'ty (pcs/box)
Φ3 (B55)	14	2,000	20,000
Φ4 (D55, D56, D60)	14	2,000	20,000
Φ5 (E55, E56, E60)	14	1,000	10,000
Φ6.3 (F55, F56, F60)	18	1,000	10,000
Φ6.3×8L (F80)	18	800	8,000
Φ8×6L (H63)	18	1,000	10,000
Φ8×10L (H10)	26	500	3,000
Φ10×10L (J10)	26	500	3,000
Φ12.5×13.5L (K14)	34	200	1,000

ORIENTATION OF POLARITY



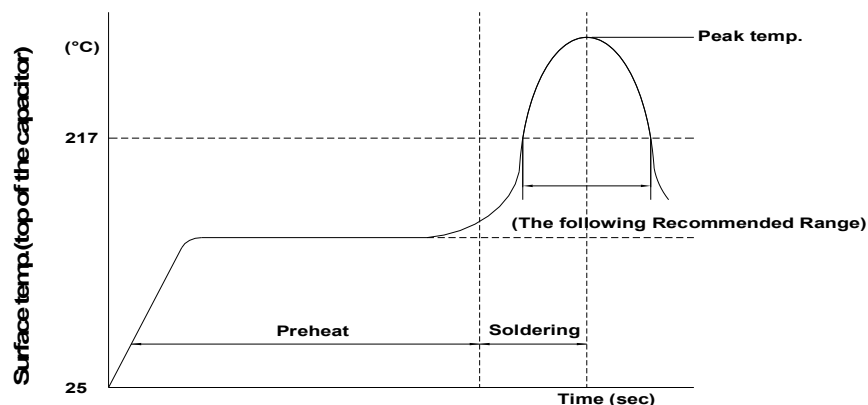
ALUMINUM ELECTROLYTIC CAPACITOR

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RECOMMENDED Pb-FREE REFLOW SOLDERING CONDITIONS

The following conditions are recommended for air or infrared reflow soldering of the surface mount capacitors onto a glass epoxy circuit board of 90X50X0.8mm(with resist)by cream solder (eutectic solder).

The temperatures shown are the surface temperature values of the top of the capacitor.



TEMPERATURE PROFILE

CASE CODE	Time of Preheat temp. (from 150 °C to 200 °C)	Time to be maintained above 217 °C	Time to be maintained above 230 °C	Peak Temp. (°C)	Reflow Cycle
B55,D55,D56,E55,E56,F55,F56,F60,F80,H63,H10,J85,J10,K14	60~100 Sec	60~70 Sec	20~30 Sec	250(10Sec ↓)	1 TIME

PRECAUTIONS TO USERS

Soldering method

The capacitors of Alchip series have no capability to withstand such dip or wave soldering as totally immerses a components to the capacitors because the following makes a difference in the stress to the capacitors.If any other reflow soldering conditions are applied,please consult us.

- 1.Location of components.(The edge sides of a PC board increases its temperature more than the center does)
- 2.Population of components.The less the component population is, the more the temperature is increased.
- 3.Material of printed circuit board.As a ceramic board needs heating up more than a glass epoxy board to reach the same board temperature,the capacitors may be damaged.
- 4.Thickness of PC board.A thick PC board needs heating up more than a thin board.It may damage the capacitors.
- 5.Size of PC board.A larger PC board needs heating up more than a small board,and it may damage the capacitors.
- 6.Location of infrared ray lamps.On IR reflow as well as hot plate reflow, heating only the reverse side of the PC board will reduce a stress to the capacitors.

Rework of soldering

Avoid reflow soldering more than once by reflow.Use a soldering iron for rework.of solder,and do not exceed an iron tip temperature of 300 °C and a max. exposure time of 5 seconds.

Mechanical stress

Do not lift up or push the capacitor after soldering.Avoid curvature of the PC board.These may damage the capacitor.
inadequately dried after a washing process,the capacitors will keep suffering from a residual solvent for long periods of time,and will be corroded while in service.

Coating on assembly board

- 1.Before coating, evaporate cleaning solvents from the assembly board.
- 2.Before conformal coating, using a buffer pre-coat which does not contain chloride is recommended to reduce stress to the capacitors.

Molding with resin

Inner pressure of a capacitor slowly increases over the service life of the capacitor with gas being produced by internal chemical reaction. If the end seal of the capacitor is completely be in danger.Also if the resin contains a large amount of chlorine ion,it will penetrate into the end seal,get into the inside element of the capacitor,and damage the capacitor while in service.

Others

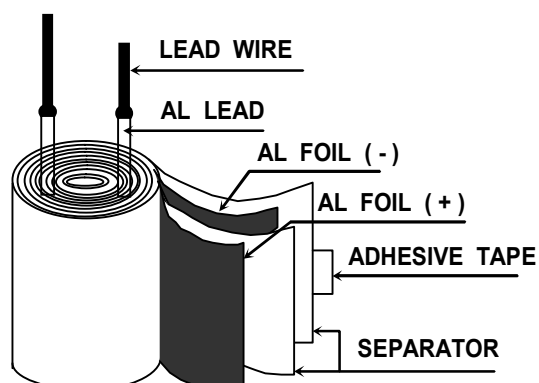
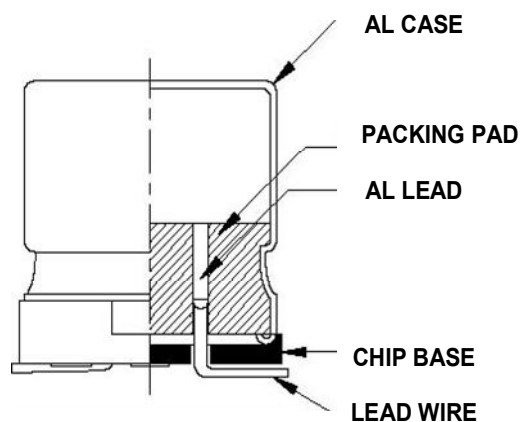
The Precautions to users for Aluminum Electrolytic Capacitors shall be applied.



ALUMINUM ELECTROLYTIC CAPACITOR

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STRUCTURE AND MATERIALS



MINIATURE SIZED TYPE CAPACITORS COMPONENT

PART NAME	MATERIALS	VENDER
LEAD WIRE	TINNED COPPER - PLY WIRE(PB-FREE)	KISTRON (KOREA/CHINA)
		KOHOKU (JAPAN/CHINA)
		NANTONG HONGYANG (CHINA)
AL LEAD	ALUMINUM 99.92%	KISTRON (KOREA/CHINA)
		KOHOKU (JAPAN/CHINA)
		NANTONG HUIFENG (CHINA)
PACKING PAD	SYNTHETIC RUBBER	SUNG NAM (KOREA/CHINA)
		CCW (CHINA)
CHIP BASE	PPA (POLY PHTHAL AMIDE)	BASE (KOREA)
		ZICVISION (JAPAN)
		SANKYO TOHOKU (CHINA)
		VIVID (CHINA)
AL CASE	COATED ALUMINUM	D.N TECH/HA NAM (KOREA)
		LINAN AOXING (CHINA)
AL FOIL (+)	FORMED ALUMINUM 99.9% OVER	SAM YOUNG (KOREA)
		K.D.K/JCC/MATSUSHITA (JAPAN)
		BECROMAL (ITALY)
		HEC/NANTONG (CHINA)
AL FOIL (-)	ETCHED ALUMINUM 98% OVER	K.D.K (JAPAN)
		K-JCC (KOREA)
		ELECON/WU JIANG FEILO (CHINA)
SEPARATOR	INSULATION PAPER	N.K.K (JAPAN)
		KAN (CHINA)
ADHESIVE TAPE	POLYPHENYLENE SULFIDE OR POLY IMIDE FILM	DAEIL/SWECO (KOREA)
		NITTO/NICHIBAN (JAPAN)



When using aluminum electrolytic capacitors, pay strict attention to the following:

1. Electrolytic capacitors for DC application require polarization.

Confirm the polarity. If used in reversed polarity, the circuit life may be shortened or the capacitor may be damaged. For use on circuits whose polarity is occasionally reversed, or whose polarity is unknown, use bi-polarized capacitors (BP-series). Also, note that the electrolytic capacitor cannot be used for AC application.

2. Do not apply a voltage exceeding the capacitor's voltage rating.

If a voltage exceeding the capacitor's voltage rating is applied, the capacitor may be damaged as leakage current increases. When using the capacitor with AC voltage superimposed on DC voltage, care must be exercised that the peak value of AC voltage does not exceed the rated voltage.

3. Do not allow excessive ripple current to pass.

Use the electrolytic capacitor at current values within the permissible ripple range. If the ripple current exceeds the specified value, request capacitors for high ripple current applications.

4. Ascertain the operating temperature range.

Use the electrolytic capacitors according to the specified operating temperature range. Usage at room temperature will ensure longer life.

5. The electrolytic capacitor is not suitable for circuits in which charge and discharge are frequently repeated.

If used in circuits in which charge and discharge are frequently repeated, the capacitance value may drop, or the capacitor may be damaged. Please consult our engineering department for assistance in these applications.

6. Apply voltage treatment to the electrolytic capacitor which has been allowed to stand for a long time.

If the electrolytic capacitor is allowed to stand for a long time, its withstand voltage is liable to drop, resulting in increased leakage current. If the rated voltage is applied to such a product, a large leakage current occurs and this generates internal heat, which damages the capacitor. If the electrolytic capacitor is allowed to stand for a long time, therefore, use it after giving voltage treatment (Note 1). (However, no voltage treatment is required if the electrolytic capacitor is allowed to stand for less than 2 or 3 years at normal temperature.)

7. Be careful of temperature and time when soldering.

When soldering a printed circuit board with various components, care must be taken that the soldering temperature is not too high and that the dipping time is not too long. Otherwise, there will be adverse effects on the electrical characteristics and insulation sleeve of electrolytic capacitors in the case of small-sized electrolytic capacitors, nothing abnormal will occur if dipping is performed at less than 260°C for less than 10 seconds.

8. Do not place a soldering iron on the body of the capacitor.

The electrolytic capacitor is covered with a vinyl sleeve. If the soldering iron comes in contact with the electrolytic capacitor body during wiring, damage to the vinyl sleeve and/or case may result in defective insulation, or improper protection of the capacitor element.

9. Cleaning circuit boards after soldering.

Some solvents have adverse effects on capacitors.

Please refer to the next page.

10. Do not apply excessive force to the lead wires or terminals.

If excessive force is applied to the lead wires and terminals, they may be broken or their connections with the internal elements may be affected. (For strength of terminals, refer to KS C IEC 60384-4 (JIS C 5101-1, JIS C 5101-4))

11. Care should be used in selecting a storage area.

If electrolytic capacitors are exposed to high temperatures caused by such things as direct sunlight, the life of the capacitor may be adversely affected. Storage in a high humidity atmosphere may affect the solderability of lead wires and terminals.

12. Surge voltage.

The surge voltage rating is the maximum DC over-voltage to which the capacitor may be subjected for short periods not exceeding approximately 30 seconds at infrequent intervals of not more than six minutes. According to KS C IEC 60384-4, the test shall be conducted 1000 cycles at room temperature for the capacitors of characteristic KS C IEC 60384-4 or at the maximum operating temperature for the capacitors of characteristics B and C of KS C IEC 60384-4 with voltage applied through a series resistance of 1000 ohms without discharge. The electrical characteristics of the capacitor after the test are specified in KS C IEC 60384-4. Unless otherwise specified, the rated surge voltage are as follows:

Rated Voltage(V)	4	6.3	10	16	25	35	50	63	80	100	120	160	200	250	315	350	400	420	450	500	550
Rated Surge Voltage(V)	5	8	13	20	32	44	63	79	100	125	150	200	250	300	365	400	450	470	500	550	600

Note 1 Voltage treatment ... Voltage treatment shall be performed by increasing voltage up to the capacitor's voltage rating gradually while lowering the leakage current. In this case, the impressed voltage shall be in the range where the leakage current of the electrolytic capacitor is less than specified value. Meanwhile, the voltage treatment time may be effectively shortened if the ambient temperature is increased (within the operating temperature range).

Note 2 For methods of testing, refer to KS C IEC 60384-4, (JIS C 5101-1, JIS C 5101-4)



CLEANING CONDITIONS

Aluminum electrolytic capacitors that have been exposed to halogenated hydrocarbon cleaning and defluxing solvents are susceptible to attack by these solvents. This exposure can result in solvent penetration into the capacitors, leading to internal corrosion and potential failure.

Common type of halogenated cleaning agents are listed below.

Chemical Name	Structural Formula	Representative Brand Name
Trichlorotrifluoroethane	$C_2Cl_3F_3$	Freon TF, Daiflon S-3
Fluorotrichloromethane	CCl_3F	Freon-11, Daiflon S-1
1,1,1-Trichloroethane	$F_2H_3Cl_3$	Chloroethane
Trichloroethylene	C_2HCl_3	Trichlene
Methyl Chloride	CH_3Cl	MC

We would like to recommend you the below cleaning materials for your stable cleaning condition taking the place of previous materials.

◎ Isopropyl Alcohol (IPA) or Water

Cleaning method: One of immersion, ultrasonic or vapor cleaning.

Maximum cleaning time: 5 minutes (Chip type: 2 minutes)

※ Do not use AK225AES

Aluminum electrolytic capacitors are easily affected by halogen ions, particularly by chloride ions.

Excessive amounts of halogen ions, if happened to enter the inside of the capacitors, will give corrosion accidents-rapid capacitance drop and vent open. The extent of corrosion accidents varies with kinds of electrolytes and seal-materials. Therefore, the prevention of halogen ion contamination is the most important check point for quality control in our production lines. At present, halogenated hydrocarbon-contained organic solvents such as Trichloroethylene, 1,1,1-Trichloroethane, and Freon are used to remove flux from circuit boards.

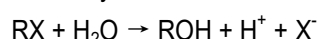
If electrolytic capacitors are cleaned with such solvents, they may gradually penetrate the seal portion and cause the ejection. When using latex-based adhesive on the capacitors rubber end seal for adhesion to a PCB, corrosion may occur depending on the kind of solvent in the adhesive. Select an adhesive as an organic solvent with dissolved polymer that is not halogenated hydrocarbon. Hot air drying is required for eliminating the solvent between the product and the PCB at 50°C~80°C after coating.

Followings are the penetration path of the halogenated solvent.

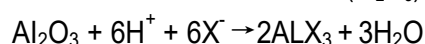
- ① Penetration between the rubber and the aluminum case
- ② Penetration between the rubber and the lead wire
- ③ Penetration through the rubber

The inside of the capacitors, the mechanism of corrosion of aluminum electrolytic capacitors by halogen ions can be explained as follows:

Halides (RX) are absorbed and diffused into the seal portion. The halides then enter the inside of the capacitors and contact with the electrolyte of the capacitors. Whereby halogen ions are made free by a hydrolysis with water in the electrolyte:



The halogen ions (X^-) react with the dielectric substance (Al_2O_3) of aluminum electrolytic capacitors:



AlX_3 is dissociated with water:



※ MANUFACTURING SITE

- SamYoung Electronics Co., Ltd. (Korea/China)

